Product data sheet

#### 1. Product profile

#### 1.1 General description

The IP4282CZ6 is designed to protect high-speed interfaces such as HDMI, DVI and DisplayPort interfaces. The device includes high-level ElectroStatic Discharge (ESD) protection diodes for the TMDS signal lines.

All TMDS intra-pairs are protected by a special diode configuration offering a low line capacitance of only 0.7 pF. These diodes provide protection to downstream components from ESD voltages up to  $\pm 8$  kV contact according to IEC 61000-4-2, level 4.

#### 1.2 Features

- 'Pass-thru' signal line routing
- Pb-free, RoHS compliant and free of Halogen and Antimony (Dark Green compliant)
- All TMDS lines with integrated rail-to-rail clamping diodes for downstream ESD protection of ±8 kV according to IEC 61000-4-2, level 4
- Matched 0.5 mm trace spacing
- Line capacitance of only 0.7 pF for each channel
- 2-channel, 6-terminal UTLP
- HDMI 1.3a compliant
- DisplayPort compliant

#### 1.3 Applications

The IP4282CZ6 is designed for HDMI receiver and transmitter port protection:

- TVs, monitors
- DVD recorders and players
- Notebooks, main board graphics cards and ports
- Set-top boxes and game consoles



## 2. Pinning information

#### Table 1. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	TMDS_CH1-	negative channel 1 ESD protection		
2	TMDS_CH1+	positive channel 1 ESD protection	1 2 3	1 2
3	GND	ground		
4	GND	ground		はは
5	n.c.	not connected		本本
6	n.c.	not connected	6 5 4 bottom view	3, 4 001aaj776

## 3. Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
IP4282CZ6	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1.45 $\times$ 0.5 mm	SOT886

## 4. Limiting values

#### Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{I}$	input voltage		GND - 0.5	+5.5	V
V <sub>esd</sub>	electrostatic discharge voltage	all pins to ground; IEC 61000-4-2, level 4; contact discharge	-8	+8	kV
T <sub>stg</sub>	storage temperature		-55	+125	°C
T <sub>amb</sub>	ambient temperature		-40	+85	°C

#### 5. Characteristics

Table 4. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{BRzd}$	Zener diode breakdown voltage	I = 1 mA		6	-	9	V
$I_{LRzd}$	Zener diode reverse leakage current	per TMDS channel; V = 3.0 V		-	-	1	μΑ
$V_{F}$	forward voltage			-	0.7	-	V
$C_{\text{ch}(\text{TMDS})}$	TMDS channel capacitance	$f = 1 \text{ MHz}$ ; $V_{\text{bias}} = 2.5 \text{ V}$	<u>[1]</u>	-	0.7	-	pF
$\Delta C_{\text{ch(TMDS)}}$	TMDS channel capacitance difference	$f = 1 \text{ MHz}$ ; $V_{\text{bias}} = 2.5 \text{ V}$	<u>[1]</u>	-	0.05	-	pF
$C_{\text{ch(mutual)}}$	mutual channel capacitance	between signal pin and pin n.c.; f = 1 MHz; V <sub>bias</sub> = 2.5 V	[1]	-	0.07	-	pF

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#### **ESD** protection for high-speed interfaces

 Table 4.
 Characteristics ...continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{dyn}}$	dynamic resistance	I = 1 A; T <sub>amb</sub> = 25 °C; IEC 61000-4-5/9				
		positive transient	-	2.4	-	Ω
		negative transient	-	1.3	-	Ω
V <sub>CL(ch)trt(pos)</sub>	positive transient channel clamping voltage	$V_{esd}$ = 8 kV HBM; $T_{amb}$ = 25 °C	[2] _	8	-	V

<sup>[1]</sup> This parameter is guaranteed by design.

<sup>[2]</sup> Human Body Model according to JESD22-A-J114D.

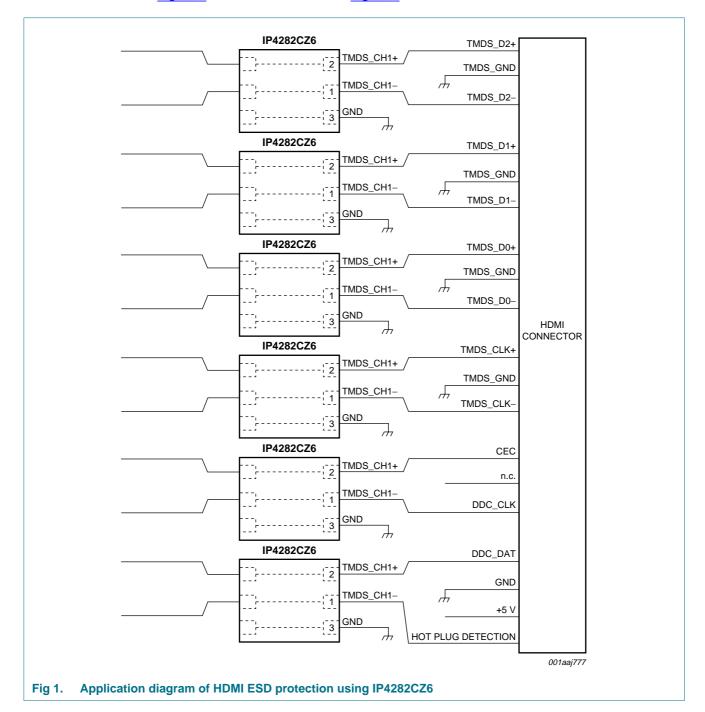
NXP Semiconductors IP4282CZ6

ESD protection for high-speed interfaces

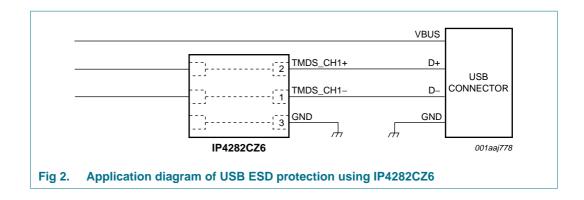
## 6. Application information

The IP4282CZ6 is designed to provide high-level ESD protection for high-speed serial data buses such as HDMI, DVI, DisplayPort, USB2.0 and other LVDS data lines.

A basic application diagram for the ESD protection of an HDMI interface is shown in Figure 1, and a USB interface in Figure 2.



#### **ESD** protection for high-speed interfaces



## 7. Package outline

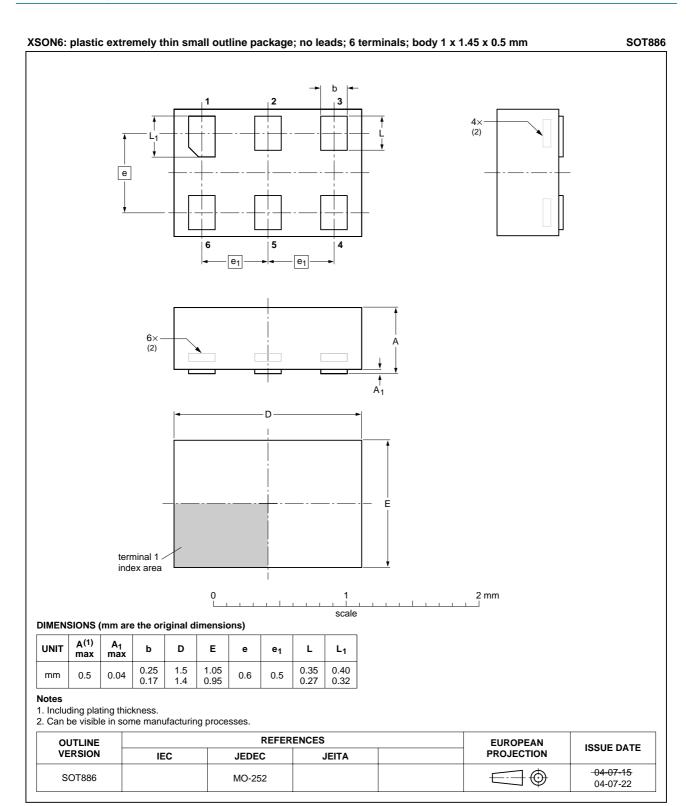


Fig 3. Package outline SOT886 (XSON6)

#### **ESD** protection for high-speed interfaces

### 8. Abbreviations

Table 5. Abbreviations

Acronym	Description
DVD	Digital Versatile Disc
DVI	Digital Visual Interface
ESD	ElectroStatic Discharge
HBM	Human Body Model
HDMI	High-Definition Multimedia Interface
LVDS	Low-Voltage Differential Signaling
RoHS	Restriction of Hazardous Substances
TMDS	Transition Minimized Differential Signaling
USB	Universal Serial Bus
UTLP	Ultra-Thin Leadless Package

## 9. Revision history

#### Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
IP4282CZ6_1	20090330	Product data sheet	-	-

#### 10.1 Data sheet status

10. Legal information

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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